



SLV3401T 30V P -Channel MOSFET

General Description

This Power MOSFET is produced using Msemitek's advanced TRENCH technology.

This advanced technology has been especially tailored to minimize conduction loss, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

Application

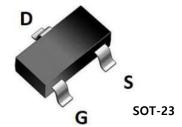
- ☑ PWM Application
- ☑ Load Switch
- ☑ Power Management

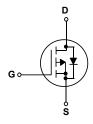
Features

- P-Channel: -30V -4.2A

 $R_{DS(on)Typ}$ =44m Ω @ V_{GS} = -4.5 V $R_{DS(on)Typ}$ = 54m Ω @ V_{GS} = -2.5V

- Very Low On-resistance R_{DS(ON)}
- Low Crss
- Fast switching
- Improved dv/dt capability





Absolute Maximum Ratings

T_C = 25°C unless otherwise noted

| Symbol | Parameter | SLV3401T | Units |
|-----------------------------------|---|-------------|-------|
| V_{DSS} | Drain-Source Voltage | -30 | V |
| I _D | Drain Current - Continuous (T _C = 25°C) | -4.2 | Α |
| ID | - Continuous (T _C = 100°C) | -2.7 | Α |
| I _{DM} | Drain Current - Pulsed (Note 1) | -25 | Α |
| V_{GSS} | Gate-Source Voltage | ±20 | V |
| P_D | Power Dissipation (T _C = 25°C) | 1.25 | W |
| R _{θJA} | Thermal Resistance, Junction-to-Ambient | 100 | °C/W |
| T _J , T _{STG} | Operating and Storage Temperature Range | -55 to +150 | °C |
| TL | Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | 300 | °C |

^{*} Drain current limited by maximum junction temperature.

Units

nΑ

Max

100

Package Marking

Symbol

 I_{GSSR}

| Part Number | Top Marking | Package | Packing Method | MOQ | QTY |
|-------------|-------------|---------|----------------|------|--------|
| SLV3401T | 3401T | SOT-23 | Tape & Reel | 3000 | 180000 |

Electrical Characteristics

Parameter

Gate-Body Leakage Current, Reverse

T_C = 25°C unless otherwise noted

Test Conditions

Min

Тур

| Off Characteristics | | | | | | | | |
|---------------------|------------------------------------|---|-----|-----|------|----|--|--|
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, I_{D} = -250 \text{ uA}$ | -30 | | | V | | |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =-30 V, V _{GS} = 0 V | | -1 | uA | | | |
| | Zelo Gate Voltage Diaili Guitelli | V _{DS} = -24V, T _C = 125°C | | -10 | uA | | | |
| I _{GSSF} | Gate-Body Leakage Current, Forward | $V_{GS} = -10V, V_{DS} = 0 V$ | - | | -100 | nA | | |

 V_{GS} = 10 V, V_{DS} = 0 V

On Characteristics

| $V_{GS(th)}$ | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = -250 uA | -1.0 | -1.6 | -2.2 | V |
|---------------------|------------------------|--|------|------|------|-------|
| R _{DS(on)} | Static Drain-Source | V _{GS} = -4.5 V, I _D =-4A | 44 | 55 | mΩ | |
| | On-Resistance | V _{GS} = -2.5 V, I _D =-1A | - | 54 | 68 | 11122 |

Dynamic Characteristics

| C _{iss} | Input Capacitance | V _{DS} = -15V, V _{GS} = 0 V, f = 1.0 MHz | 1 | 692 | - | pF |
|------------------|------------------------------|---|---|-----|---|----|
| Coss | Output Capacitance | | 1 | 69 | - | pF |
| Crss | Reverse Transfer Capacitance | | | 55 | - | рF |

Switching Characteristics

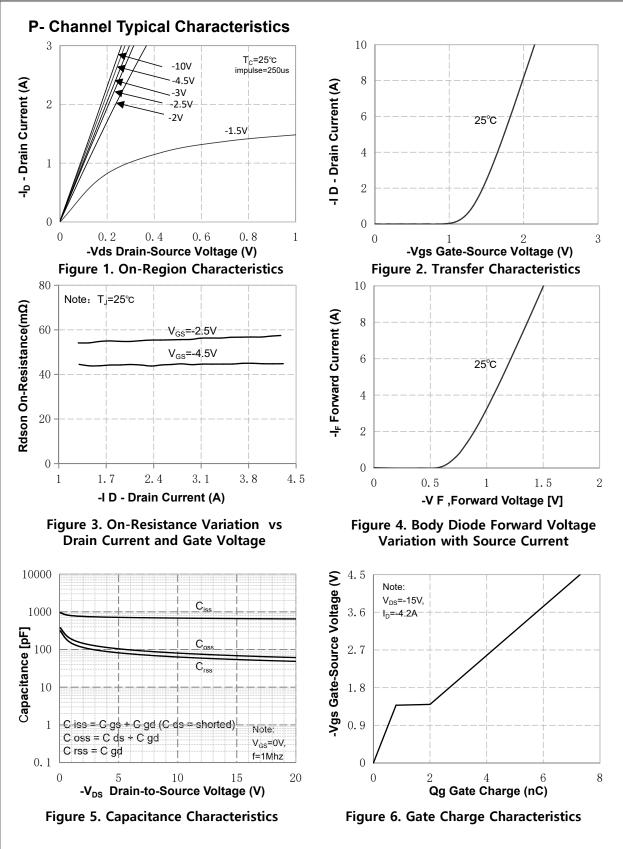
| $t_{d(on)}$ | Turn-On Delay Time | | - | 8 | | ns |
|----------------|---------------------|--|---|-----|---|----|
| t _r | Turn-On Rise Time | V_{GS} =-10V, V_{DS} =-15V, I_D =-4.2A, | ı | 30 | - | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | $R_G = 6\Omega$ | ı | 20 | - | ns |
| t _f | Turn-Off Fall Time | 1 [| | 28 | | ns |
| Q_g | Total Gate Charge | $V_{DS} = -15 \text{ V}, I_{D} = -4.2 \text{A},$ | - | 7.3 | | nC |
| Q_{gs} | Gate-Source Charge | V _{GS} = -4.5V | ı | 8.0 | 1 | nC |
| Q_{gd} | Gate-Drain Charge | | | 1.2 | | nC |

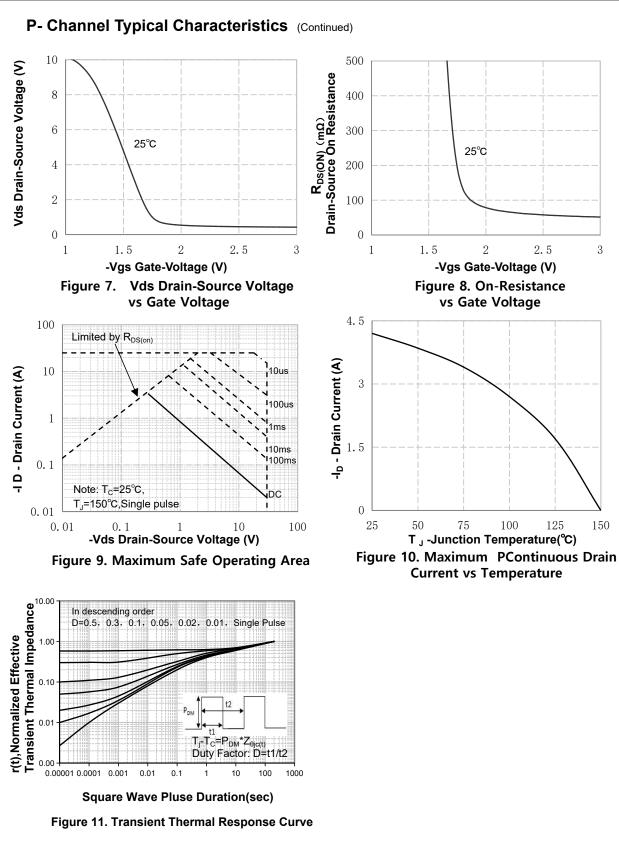
Drain-Source Diode Characteristics and Maximum Ratings

| Is | Maximum Continuous Drain-Source Diode Forward Current | - | -4.2 | Α |
|-----------------|---|---|----------|---|
| I _{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | -15 | Α |
| V_{SD} | Drain to Source Diode Forward Voltage, V $_{GS}$ = 0V, I $_{SD}$ =-3A, T $_{J}$ = 25 $^{\circ}$ C | | -1.2 | V |

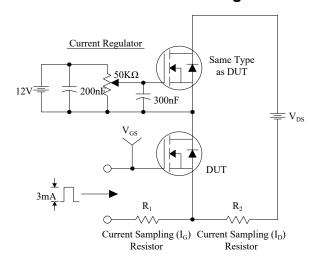
Notes:

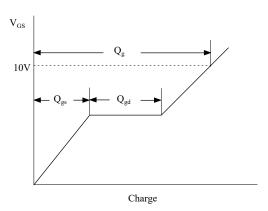
- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
- 2. Device mounted on FR-4 PCB, 1inch x 0.85inch x 0.062 inch
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



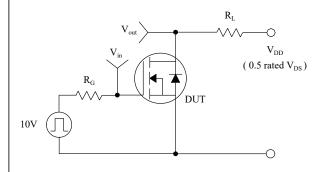


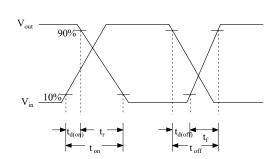
Gate Charge Test Circuit & Waveform



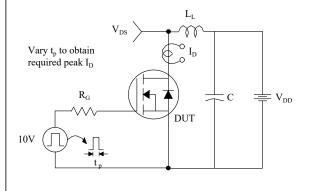


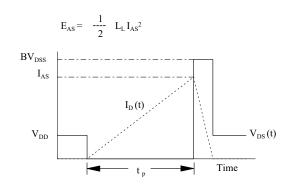
Resistive Switching Test Circuit & Waveforms



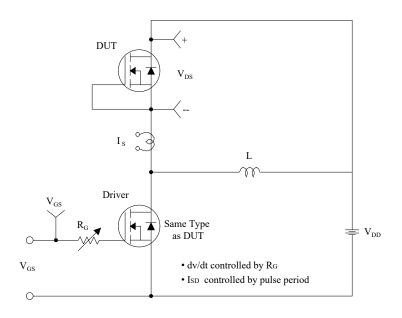


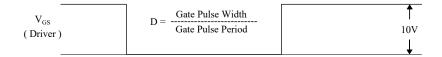
Unclamped Inductive Switching Test Circuit & Waveforms

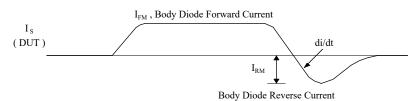


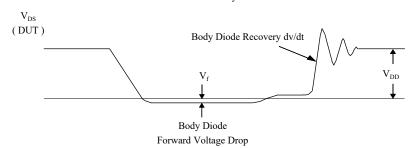


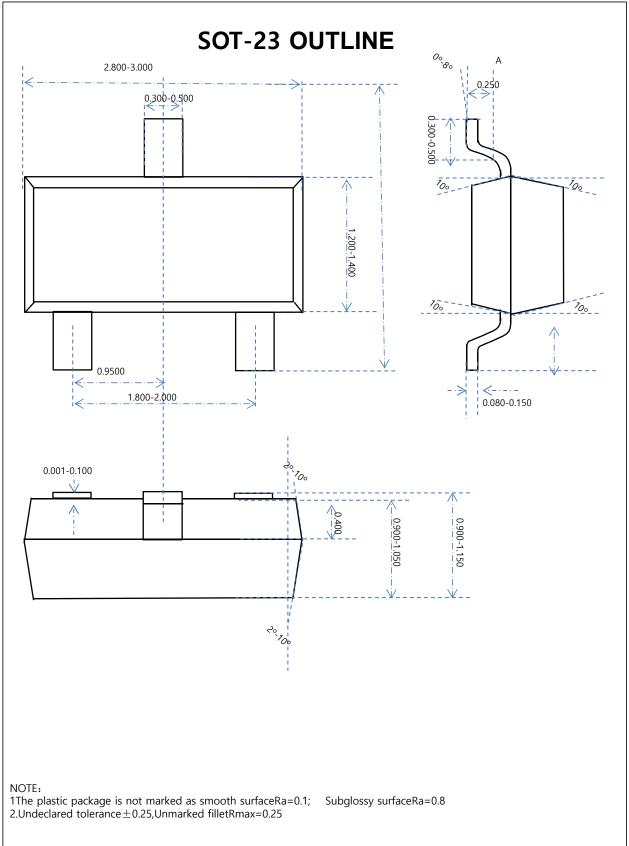
Peak Diode Recovery dv/dt Test Circuit & Waveforms











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